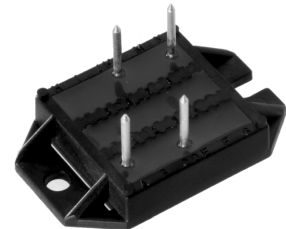
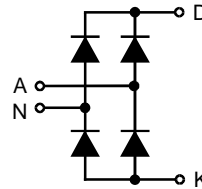


Single Phase Rectifier Bridge

$I_{dAVM} = 54 \text{ A}$
 $V_{RRM} = 800-1600 \text{ V}$

Preliminary data

V_{RSM} V	V_{RRM} V	Type
900	800	VUO 54-08NO7
1300	1200	VUO 54-12NO7
1500	1400	VUO 54-14NO7
1700	1600	VUO 54-16NO7



Symbol	Test Conditions	Maximum Ratings	Features	
$I_{dAV} \text{ ①}$	$T_C = 100^\circ\text{C}$, module	54 A	<ul style="list-style-type: none"> • Package with DCB ceramic base plate • Isolation voltage 3000 V~ • Planar passivated chips • Low forward voltage drop • Leads suitable for PC board soldering 	
I_{FSM}	$T_{VJ} = 45^\circ\text{C}$; $V_R = 0$	$t = 10 \text{ ms}$ (50 Hz), sine		300 A
		$t = 8.3 \text{ ms}$ (60 Hz), sine		320 A
I^2t	$T_{VJ} = T_{VJM}$ $V_R = 0$	$t = 10 \text{ ms}$ (50 Hz), sine		260 A
		$t = 8.3 \text{ ms}$ (60 Hz), sine		280 A
T_{VJ}	$T_{VJ} = T_{VJM}$ $V_R = 0$	$t = 10 \text{ ms}$ (50 Hz), sine		450 A ² s
		$t = 8.3 \text{ ms}$ (60 Hz), sine	425 A ² s	
T_{VJM}		-40...+150 °C		
T_{stg}		150 °C		
V_{ISOL}	50/60 Hz, RMS $I_{ISOL} \leq 1 \text{ mA}$	$t = 1 \text{ min}$	2500 V~	
		$t = 1 \text{ s}$	3000 V~	
M_d	Mounting torque (M4)	1.5 - 2 Nm 14 - 18 lb.in.		
Weight	typ.	18 g		

Features

- Package with DCB ceramic base plate
- Isolation voltage 3000 V~
- Planar passivated chips
- Low forward voltage drop
- Leads suitable for PC board soldering

Applications

- Supplies for DC power equipment
- Input rectifiers for PWM inverter
- Battery DC power supplies
- Field supply for DC motors

Advantages

- Easy to mount with two screws
- Space and weight savings
- Improved temperature and power cycling capability
- Small and light weight

Symbol	Test Conditions	Characteristic Values
I_R	$V_R = V_{RRM}$; $T_{VJ} = 25^\circ\text{C}$	$\leq 0.5 \text{ mA}$
		$V_R = V_{RRM}$; $T_{VJ} = T_{VJM}$
V_F	$I_F = 55 \text{ A}$; $T_{VJ} = 25^\circ\text{C}$	$\leq 1.46 \text{ V}$
V_{T0}	For power-loss calculations only	0.8 V
r_T		13 mΩ
R_{thJC}	per diode; DC current	1.1 K/W
	per module	0.28 K/W
R_{thJH}	per diode; DC current	1.6 K/W
	per module	0.4 K/W
d_s	Creeping distance on surface	11.2 mm
d_A	Creepage distance in air	9.7 mm
a	Max. allowable acceleration	50 m/s ²

Data according to IEC 60747 refer to a single diode unless otherwise stated
 ① for resistive load at bridge output.

IXYS reserves the right to change limits, test conditions and dimensions.

Dimensions in mm (1 mm = 0.0394")

